

# NPN EPITAXIAL PLANAR SILICON TRANSISTOR

# CSC1815



TO-92 Plastic Package

## Audio Frequency General Purpose and Driver Stage Amplifier Applications. Complementary CSA1015

#### ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub>=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Base Voltage	V <sub>CBO</sub>	60	V
Collector Emitter Voltage	V <sub>CEO</sub>	50	V
Emitter Base Voltage	V <sub>EBO</sub>	5	V
Collector Current Continuous	Ι <sub>C</sub>	150	mA
Base Current	Ι <sub>Β</sub>	50	mA
Collector Power Dissipation	Pc	625	mW
Operating And Storage Junction Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 to +125	℃

### THERMAL RESISTANCE

Junction to case R <sub>th(j-c)</sub> 250	°C/W
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### ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless specified otherwise)

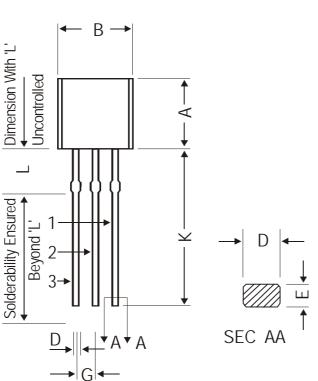
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Cut off Current	I <sub>CBO</sub>	$V_{CB} = 60V, I_{E} = 0$			100	nA
Emitter Cut off Current	I <sub>EBO</sub>	$V_{EB} = 5V, I_{C} = 0$			100	nA
DC Current Gain	*h <sub>FE</sub>	I <sub>C</sub> =2mA, V <sub>CE</sub> =6V	70		700	
	h <sub>FE</sub>	$I_C = 150 \text{mA}, V_{CE} = 6 \text{V}$	25			
Collector Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =100mA, I <sub>B</sub> = 10mA			0.25	V
Base Emitter Saturation Voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =100mA, I <sub>B</sub> = 10mA			1.0	V

### **Dynamic Characteristics**

Transition Frequency	ft	V <sub>CE</sub> =10V, I <sub>C</sub> =1mA,	80			MHz
		f=100MHz				
Collector Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> =10V,I <sub>E</sub> =0,			3	pF
		f=1MHz				
Base Spreading Resistance	rbb'	V <sub>CB</sub> =10V, I <sub>E</sub> =1mA,		50		Ω
		f=30MHz				
Noise Figure	NF	V <sub>CE</sub> =6V, I <sub>C</sub> =0.1mA,			10	dB
		R <sub>g</sub> =10KΩ, f=1KHz				
CLASSIFICATION	0	Y	GR		BL	
*h <sub>FE</sub>	70 - 140	120 - 240	200 -	400	350 - 700	

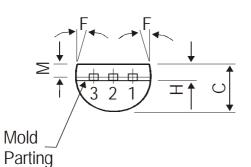
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DIM	MIN.	MAX.			
А	4.32	5.33			
В	4.45	5.20			
С	3.18	4.19			
D	0.41	0.55			
E	0.35	0.50			
F	5 DEG				
G	1.14	1.40			
Н	1.20	1.40			
К	12.70				
L	1.982	2.082			
М	1.03	1.20			

All dimensions are in mm





PIN CONFIGURATION1. BASE2. COLLECTOR3. EMITTER

The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet. The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

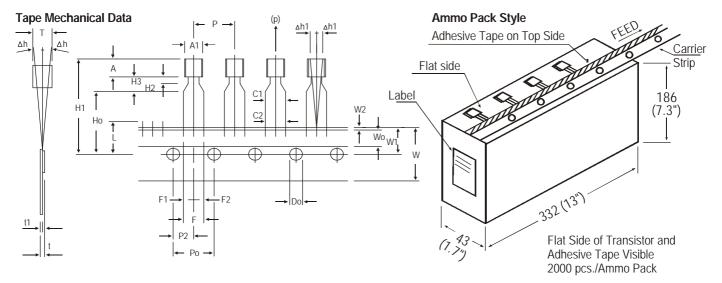
## **Packing Details**

Line

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

# **TO-92 Plastic Package**

# **TO-92 Tape and Ammo Pack**



#### All dimensions are in mm

		SPECIFICATION				
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		NOTES
BODY HEIGHT	A	4.8		5.2		1. Maxim
BODY THICKNESS	T	3.9		4.2		leads
PITCH OF COMPONENT	P		12.7		± 1.0	2. Maxin
<sup>*1</sup> FEED HOLE PITCH <sup>*2</sup> FEED HOLE CENTRE TO	Po		12.7		± 0.3	betwe excee
COMPONENT CENTRE	P2		6.35		± 0.4	3. Holdd
DISTANCE BETWEEN OUTER LEADS	F		5.08		+ 0.6 - 0.2	the ec shall b
*3 COMPONENT ALIGNMENT SIDE VIEW	∆h		0	1.0		4. There
*4 COMPONENT ALIGNMENT FRONT VIEW	h1		0	1.3		conse
TAPE WIDTH	W		18		± 0.5	tape.
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	5. A tape holes
HOLE POSITION	W1		9		+ 0.7 - 0.5	compo
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2	6. Splice
LEAD WIRE CLINCH HEIGHT	Но		16		± 0.5	sproc
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	REMAR
*5 TOTAL TAPE THICKNESS	t		0.54	1.2		*1 Cumu
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4 - 0.1	* <sup>2</sup> To be
STAND OFF	H2	0.45		1.45		
CLINCH HEIGHT	H3			3.0		*3 At top
LEAD PARALLELISM	C1 - C2			0.22		*4 At top
PULL - OUT FORCE	(p)	6N				*5 t1 0.

kimum alignment deviation between ds will not to be greater than 0.2mm. ximum non-cumulative variation ween tape feed holes shall not eed 1 mm in 20 pitches. ddown tape will not exceed beyond edge(s) of carrier tape and there Il be no exposure of adhesive. ere will be no more than three (3) secutive missing components in a e. ape trailer, having at least three feed

es are provided after the last nponent in a tape.

ices should not interfere with the ocket feed holes.

#### RKS

- mulative pitch error 1.0 mm/20 pitch
- be measured at bottom of clinch
- op of body
- op of body
- 0.3 0.6 mm

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